Effect of Tin Electrode (Sn), Electrode Distance and Thin Layer Size of Zinc Phthalocyanine (ZnPc) to Resistance Changes with Ozone Exposure

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ABSTRACT

This study was aimed to determine the effect of tin electrode distances and the thickness of a thin layer of ZnPc (Zinc phtyalocyanine) toward changes in resistance with ozone exposure. Tin deposition on the glass surface was conducted using spraying method. The reaction between ozone and ZnPc produces electrical properties that can be read through the resistance value of the multimeter. Based on this study, it was investigated that the smaller a distance between the electrode and the thicker deposition of ZnPc lead to the less resistance. This showed that a thin layer of the conductivity increases along with the longer exposure to ozone gas. The movement of electrons with the hole was free.

Key word: ZnPc (Zinc phtyalocyanine), spraying method, tin electrode, ozone

INTRODUCTION

The ozone molecule contains three oxygen (O_3) atoms and is relatively unstable compared to $O_2[1]$. The ozone in stratosphere is harmless to humans, unless in the troposphere[2]. Ozone that formed by human activity is very harmful, therefore it is necessary to develop a method or tool to reduce the risk. The choice of sensor method was determined by the ability of the sensor in detecting substances to be detected. The ability of substance detection includes sensitivity, selectivity, response and recovery time, stability, and endurance[3]. The characteristics of ideal sensor are simple operation, low noise, and low production cost, which is the most important aspect[4].

The selection of gas sensor method is determined from how sensitive the sensor to detect the substance. One of organic material with a detectable gas characteristic which able to fabricate thin layer is phtalocyanine (Pc)[5]. The conductive characteristic, particularly from Pc is metal phtalocyanine (MPc) that being concerned nowadays, due to its electrical, optical, and structure properties that can be applied as gas and solar cell sensors. Commonly, the polymorph of MPc is classified as α -stable metaphase and β -stable phase. The principal difference between these two polymorphs is the angel slope of the molecule in the column. The advantage of the MPc compared to inorganic

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compounds is easier manufacturing which can be operated at the lower temperature and even on the room temperature[6].

The previous research showed that the thin layer of ZnPc deposited on the PCB can be utilized as ozone gas sensor. However, it has short durability due to rapid rusted therefore cannot be stored for a long time[8]. This study was employed tin (Sn) as an electrode. The previous studies have investigated that tin compounds has been utilized to grow SnCl₄.5H₂O on the surface of the glass using fluorine (F) dopant [9], SnO₂ using tantalum (Ta) dopant [10], SnCl₄.5H₂O using NH₄F dopant [11], and SnO₂ using Sb dopant [12]. The technique of tin compound deposition on the glass surface has been conducted using spraying technique. The deposition technique was chosen depends on various aspects such as obtainable and simple handling.

EXPERIMENT

Chemicals and instrumentation

Materials used in this study such as the glass for preparations with a thickness of 1.2 mm, ethanol, ZnPc (Sigma Aldrich, 97%), $SnCl_2 \cdot 5H_2O(Riedel-de Haen, 98\%)$, NH_4F (Merck, 98%) and ozone gas.

The equipment used in this study such as digital scales, vacuum evaporator devices with vacuum pumps (maximum pressure $4x10^{-4}$ Torr), BX 53 Motorized Olympus optical microscope and S2X 16 Olympus, Shimadzu 8400S FT-IR Spectrophotometer, HELES UX 37 digital multimeter TR and ozonator that functional in converting free air from the environment into ozone gas. The equipment was self-assembled by the researcher.

Preparation of tin solution

A total of 1.4 grams of $SnCl_2 \cdot 5H_2O$ dissolved in 20 mL of ethanol was added by 0.24 grams of NH_4F , the mixture was stirred and sonicated for 20 min. the result was obtained in a white solution [13].

ZnPc thin layer deposition on glass

Deposition of ZnPc thin layer on aglass was performed by evacuation vacuum method using vacuum evaporator. 0.005 g of ZnPc powder was weighed and placed on ceramic crucible. The distance between glass and ZnPc was maintained 5 cm prior to the deposition and conducted vacuum evaporation for 1 hour. Deposition was undertaken by two time variations of 25 and 45 min using 1 volt voltage. A thin layer of ZnPc coated on the glass was heated (scalded) in an oven at 100°C for 5 hours.

Activity test of changes in ozone sensor resistance

Activity test of the ZnPc layer above the glass was based on a measurement of the electrical properties of the initial ZnPc thin layer resistance value and after the exposure of the ozone gas. Ozone gas was synthesized from oxygen environment using ozonator device. Ozone synthesis was conducted using plasma discharge.

RESULT AND DISCUSSION

Tin Electrode Deposition on Glass

The fabrication of glass as a medium of thin layer growth in this study was carried out using Sn(II), which is doped with NH_4F , and initiated by making interdigital pattern with variation of electrode distance. The distance of the electrode was maintained in two variations, such as 1 and 2 mm. Interdigital pattern was printed using aluminum. The glass that has been glued using aluminum is heated at 450°C for 60 minutes to remove unnecessary particle which still attached to the glass surface through evaporation. The process was continued by spraying and heating of Sn(II). This step was repeated until obtained a small resistance which indicates an increase of the conductivity of the glass. To determine the uniformity of Sn(II) deposited on the glass surface, it was necessary to observe the surface morphology using an optical microscope.



Figure 1. Deposition of results (a). Electrode pattern (b). Surface electrode (c). Among the electrodes

Observations of surface morphology was indicated that the large-sized grains and electrode growth were not completely similar. This was due to the process of Sn(II) deposition by using spraying equipment produced larger grains and conducted manually. The duration of spraying and the conductivity result can be seen in Table 1.

Table 1. Variation of spraying duration and the resistance result			
Spraying	Weight of	Resistance	Resistance
repetition/	tin/ (g)	distances of 1	distances of
(times)		$cm/(M\Omega)$	2.5 cm/(M\Omega)
5	0.0008	0.04	0.07
7	0.0039	0.02	0.03
9	0.0126	0.02	0.09
11	0.0134	0.02	0.03
13	0.0154	0.01	0.03
15	0.0234	0.01	0.02

Table 1. Variation of spraying duration and the resistance result

Table 1 showed that the longer spraying and heating, the resistance was getting smaller. This indicates the increase of Sn(II) oxide crystalline formed, the crystals arranged more homogenously with higher density. The electricity mechanism of SnO that doped using NH₄F was expected similar to NiO semiconductors using dopant of Li₂O [14].The replacement of F⁻ ion to O²⁻ position leads to Sn charge around F-becomes Sn⁺¹. The change of Sn charge cause the electrons in the crystal structure move freely. The movement of electrons in this structure generates a readable electrical conductivity by decreasing the resistance value.

ZnPc Layer Surface Morphology

The morphology of thin layer was determined by the vacuum evaporator method in deposition of the thin layer on glass surface. This method was very beneficial because solid ZnPc without modification can directly be evaporated. It leads to the layer becomes softer, which enables gas absorption optimization.



Figure 2.Electrode picture after deposition of thin layer : (a) Electrode pattern (b) ZnPc deposition for 25 minutes (c) ZnPc deposition for 45 minutes

The indications of fine layers which are well deposited include the deposition result was homogeneous. It was observed using the microscope which was not easily released. The longer the deposition time leads to the amount of material deposited on the substrate increases which indicated by thicker layer. The thickness of the resulting layer was expected to absorb more ozone gas. To determine the effect of thickness on the ozone absorption, the influence of the exposure duration to resistance were measured.



Figure 3.Surface morphology after deposition : (a) above tin electrode (b) above the surface of the substrate

The thin layer surface after the treatment at 100°C for 5 hours was observed thinner, especially on thin layer with a 25 minute deposition time. This is due to the time of the layer annealing process of the long fibers set about to break up and arrange themselves into neat layers. This process was aimed to strengthen the coating on the electrode surface and increasing the homogeneity of the atoms.

Effect of Electrode Distance on Thin Layer Resistance

The effect of the distance toward resistance in this research was investigated by varying the distance between electrodes. The correlation between resistance and distance can be seen in Figure 1 and 2.



Figure 1. The correlation between resistance and exposure time at 1 mm electrode distance with 45 minute deposition time



Figure 2. The correlation between resistance and exposure time at 2 mm electrode distance with 45 minute deposition time

Figure 1 and 2 showed that resistance decreases along with the duration of exposure. The decrease of the resistance value indicates a reaction between ozone and the ZnPc thin layer which depicted in equations 1 and 2.

$$O_{3} + ZnPc \longrightarrow (O_{3}, ZnPc) \longrightarrow O_{3}^{-} + ZnPc^{+}$$
(1)
$$O_{3}^{-} + ZnPc \longrightarrow (O_{3}^{-}, ZnPc) + charge \ loader$$
(2)

Ozone exposed to thin layer surfaces have role as an electron acceptor derived from the Pc chain. This displacement of electrons causes many holes formation. Load The journal homepage www.jpacr.ub.ac.id 57 p-ISSN : 2302 – 4690 | e-ISSN : 2541 – 0733 transfer causes ozone to form O^{3-} anion, while the electrons in the ZnPc layer are delocalized. Hence, it was easier to move and generated electric current. The longer the ozone which was exposed to ZnPc, the charge carrier electrons will increase. Thus, the thinner layer becomes conductive faster. This result has been investigated from the decreasing value of resistance, along with longer exposure process time. ZnPc used in this study is one of the examples of p-type semiconductor (electron deficient). According to the earlier study which used PCB as electrodes, the resistance has been decreasing since the first hour of measurement[15]. This occurred because Cu metal in the PCB has higher electric conductivity than Sn.

Effect of ZnPc Layer Coating on Layer Resistance

The effect of thickness on the amount of ozone absorbed was showed in Figure 3 and 4.



Figure 3. The correlation between resistance and ozone exposure time of the ZnPc layer deposited for 25 minutes



Figure 4. The correlation between resistance and ozone exposure time of the ZnPc layer deposited for 45 minutes

The exposure of ozone from the second to the fourth day leads to the decrease of resistance in both deposition time for 25 and 45 min. However, a higher decrease was observed on the thicker layer (45 minutes). Changes in resistance is an indication of interaction between ozone gas and the thin layer. The longer ZnPc layer exposed to The journal homepage www.jpacr.ub.ac.id 58

ozone afforded the smaller resistance. This result showed that the conductivity was increasing. ZnPc is an example of electron-deficient p-type semiconductor. The deficiency of electron causes the formation of hole, which is described as an acceptor that can receive electron. When ozone is exposed on a substrate surface that has been deposited on thin layer, the ozone functions as a charge carrier (electron excess) will fill the empty space on the thin layer. This electron movement provides electrical current. The increase of the electron transfer may lead to the higher conductivity. This was clearly seen in Figure 4 and 5 which indicated the longer exposition time of ZnPc to ozone gas results in smaller resistance. The figures also showed that ZnPc in deposition time for 45 min leads to decreasing of higher resistance. This is because ZnPc layer thickness has more empty space therefore the movement of electron was freer.

CONCLUSION

The electrode distance applied in this study was very influential on the generated resistance. The smaller of electrode distance leads to lower the resistance and enhance the conductivity. Deposition of thin films with different times afforded the different layer thickness. The thicker of the layer resistance cause decreasing of the ozone absorbed.

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